

Dual N-Ch 20V Fast Switching MOSFET VDS=20V, ID=11A ,RDS(ON)=7.2mΩ

General Description

The PAN82TE33F the low RDSON trenched N-CH MOSFETs with robust ESD protection. This product is suitable for Lithium-ion battery pack applications. The efficiency for power switching and load switching application., this device also comply with the RoHS and Green Product requirement with full function reliability approved.

➢ <u>Feature</u>

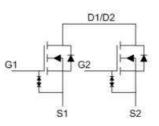
- •Low drain-source ON resistance
- •Green Device Available
- ●ESD Protected Embedded
- •DFN2X3-6L package design





> <u>Application</u>

- Load Switch
- Portable Equipment
- Battery Powered System



Absolute Maximum Ratings

Parameter	Symbol	Rating	Units
Drain-Source Voltage	Vds	20	V
Gate-Source Voltage	Vgs	±12	V
Continuous Drain Current, Vos @ 4.5V1	Id@Ta=25°C	11	А
Continuous Drain Current, VGs @ 4.5V1	Id@Ta=70°C	8.8	A
Pulsed Drain Current ₂	Ідм	70	A
Total Power Dissipation1	PD@TA=25°C	1.56	W
Storage Temperature Range	Тѕтс	-55 to 150	°C
Operating Junction Temperature Range	TJ	-55 to 150	°C
Thermal Resistance Junction-Ambient ₁ (t ≤10s)	Reja	80	°C/W



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Electrical Characteristics (TJ=25°C Unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Drain-Source Breakdown Voltage	BVDSS	Vgs=0V , Ib=250uA	20			V	
Static Drain-Source On-Resistance2		Vgs=4.5V , Ib=5.5A			7.2		
		Vgs=4.0V , Ib=5.5A			7.5		
	RDS(ON)	Vgs=3.7V , Id=5.5A			8.2	mΩ	
		Vgs=3.1V , Id=5.5A			9		
		Vgs=2.5V , Ib=5.5A			10.2		
Gate Threshold Voltage	VGS(th)	Vgs=Vbs , Ib =250uA	0.5		1.5	V	
Drain-Source Leakage Current	IDSS	Vds=18V, Vgs=0V, Tj=25°C			1	– uA	
	IDSS	Vds=18V , Vgs=0V , Tj=55°C			5		
Gate-Source Leakage Current	lgss	Vgs=±12V , Vds=0V			±10	uA	
Forward Transconductance	gfs	Vds=5V , Id=5.5A		38		S	
Total Gate Charge (4.5V)	Qg			23			
Gate-Source Charge	Qgs	Vbs=16V , Vgs=4.5V , Ib=11A		3.5		nC	
Gate-Drain Charge	Qgd			8.4			
Turn-On Delay Time	Td(on)			10.2			
Rise Time	Tr	$V_{DD}=16V$, $V_{GS}=4.5V$,		41		- ns	
Turn-Off Delay Time	Td(off)	Rg=6ΩID=5.5A		67			
Fall Time	Tf			31			
Input Capacitance	Ciss			1767			
Output Capacitance	Coss	Vos=10V , Vos=0V , f=1MHz		184		pF	
Reverse Transfer Capacitance	Crss			155			

Diode Characteristics

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Continuous Source Current1	ls	Va Va OV Force Current			11	А
Pulsed Source Current ₂	lsм	V _G =V _D =0V , Force Current			70	А
Diode Forward Voltage2	Vsd	Vgs=0V , Is=11A , Tj=25°C			1.2	V

Note :

1. The data tested by surface mounted on a 1 inch₂ FR-4 board with 2OZ copper, t \leq 10s.

2.The data tested by pulsed , pulse width $\leq~$ 10us , duty cycle $\leq~$ 1%



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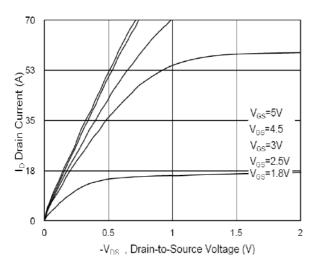


Fig.1 Typical Output Characteristics

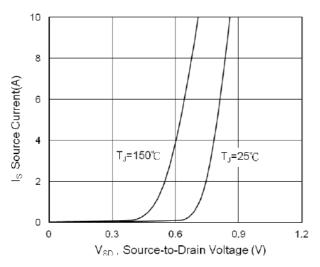


Fig.3 Forward Characteristics Of Reverse

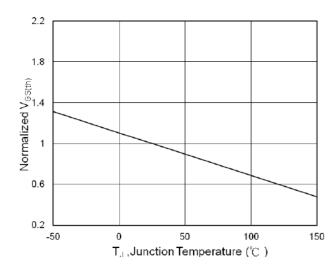


Fig.5 V_{GS(th)} vs. T_J

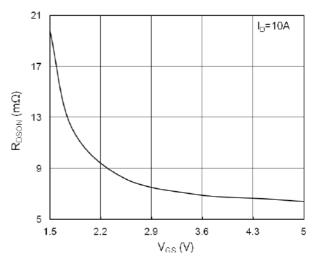


Fig.2 On-Resistance vs. Gate-Source

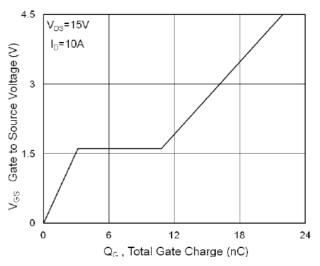


Fig.4 Gate-Charge Characteristics

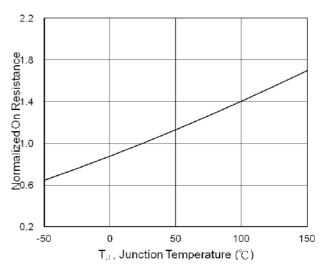
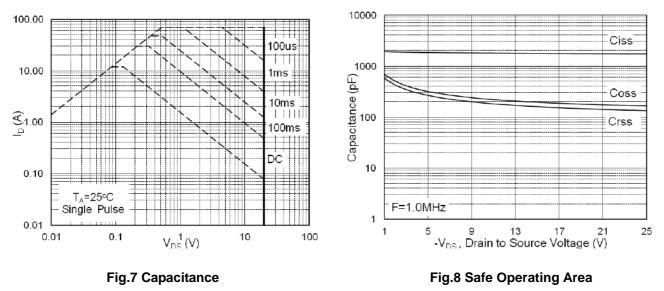


Fig.6 Normalized R_{DSON} vs. T_J



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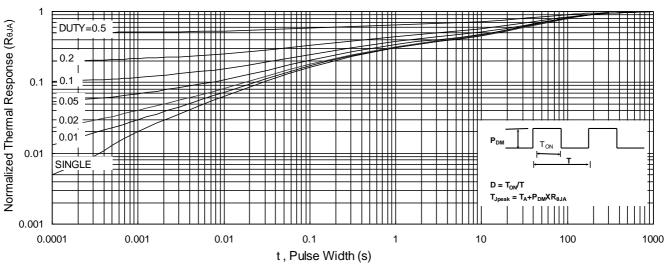
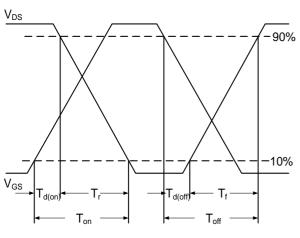


Fig.9 Normalized Maximum Transient Thermal Impedance





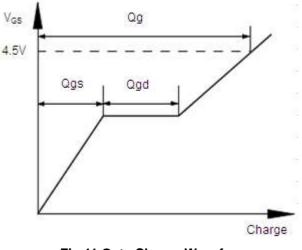


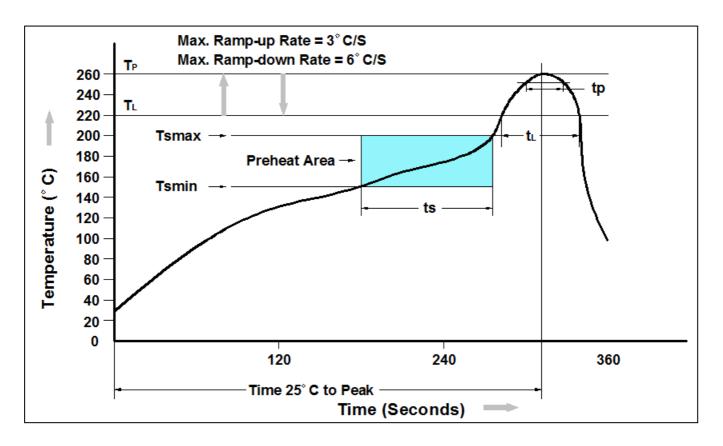
Fig.11 Gate Charge Waveform



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Recommand IR Reflow Soldering Thermal Profile



Profile Feature	Pb-Free Assembly Profile	
Temperature Min. (Tsmin)	150°C	
Temperature Max. (Tsmax)	200°C	
Time (ts) from (Tsmin to Tsmax)	60-120 seconds	
Average Ramp-up Rate (tL to tP)	3°C/second max.	
Liquidous Temperature (TL)	217°C	
Time (tL) Maintained Above (TL)	60 – 150 seconds	
Peak Temperature	260°C +0°C / -5°C	
"ime (tP) within 5°C of actual Peak Temperature 30 seconds		
Ramp-down Rate (TP to TL) 6°C/second max		
Time 25°C to Peak Temperature	8 minutes max.	

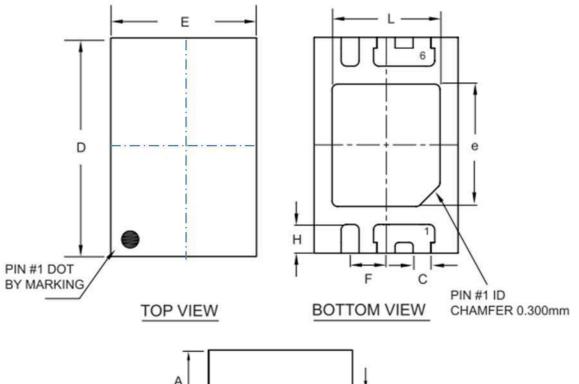
Ordering Information

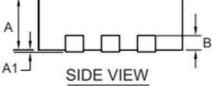
Part Number	Description	Quantity
PAN82TE33F	DFN2X3-6L Reel	3000 pcs



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Package Information (DFN2X3-6L)





	MILLIMETERS		INC	HES
SYMBOLS	MIN	MAX	MIN	MAX
A	0.700	0.800	0.028	0.031
A1	0.000	0.050	0.000	0.002
D	2.950	3.050	0.116	0.120
E	1.950	2.050	0.077	0.081
н	0.350	0.450	0.014	0.018
L	1.450	1.550	0.057	0.061
e	1.650	1.750	0.065	0.069
В	0.195	0.211	0.0076	0.008
С	0.200	0.300	0.008	0.012
F	0.500 BSC		0.020	BSC



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